Products > High Power LEDs > SuperBeamLED



Features / Options

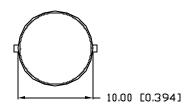
- ► State-of-the-Art, High Brightness Chip Technology
- ► Choice of Colors and Lens Finishes
- ► Maintenance Free Long Life

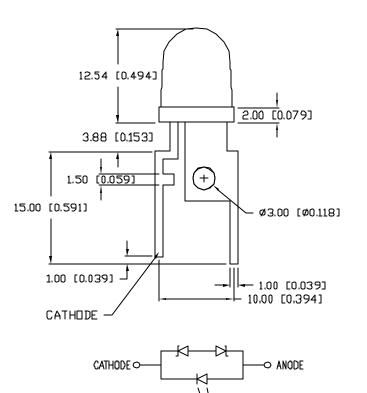
Applications / Uses

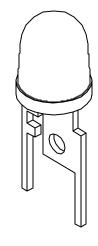
- ► Flashlights
- ► Illuminating Signs/Artwork
- ► Decorative Lighting
- ▶ Backlighting

Part Number:	Brightness	Dice Material	Emitted Color	Peak Wavelength	Epoxy Lens	Operating Typ Vf (V)	Intensity Typ, mcd @ 20 mA	View Angle 2x Theta	
SSL-LX100T123SIC	High	AlInGaP	Red	630	Clear	2.0	35 lm	25	_
SSL-LX100T123SYC	High	AlInGaP	Yellow	590	Clear	2.0	35 lm	25	_
SSL-LX100T123UPGC	High	InGaN	Green	525	Clear	3.5	55 lm	25	_

SSL-LX100T123SYC







ELECTRO-OPTICAL CHARACTERISTICS TA=25°C

PARAMETER	SYMB\!\]L	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH			590		nm	_
FORWARD VOLTAGE	۷f		2.4	3.0	V	If=350mA
REVERSE VOLTAGE	٧r	5			V	I _Γ =10μΑ
AXIAL INTENSITY	Ιv	27	35		lm	I _f =350mA
VIEWING ANGLE			25		2x thete	ייייסטט-ויי
EMITTED COLOR:	YELLOW					
EPOXY LENS FINISH:	CLEAR					

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS		
PEAK FORWARD CURRENT*	500	mA		
STEADY CURRENT	350	mA		
POWER DISSIPATION	1. 4	W		
DERATE FROM 25°C	- 1.2	mW∕°C		
OPERATING, STORAGE TEMP.	- 40 TO +85	° C		
SOLDERING TEMP.	260	° C		
2.0mm FROM BODY	3	SEC		

*T<10uS



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECINAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAU SIZE=±0.05 (±0.002), LEAU LENGTH=±0.75 (±0.030). MN= +DECINAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.127 (±0.005).

REV. PART NUMBER SSL-LX100T123SYC

ø10.00mm 1 WATT THROUGH HOLE, HIGH POWER LED. 590nm AlinGaP YELLOW LED, WATER CLEAR LENS.

CONFIDENTIAL INFORMATION

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 $\begin{array}{c} \underline{\text{Reliablity Note}} \\ \text{Our nany years of experience data accumulation indicate that} \end{array}$ SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



DRAWN BY:

CHECKED BY: APPROVED BY: DATE: 12.19.07

PAGE: 1 OF 1 SCALE: N/A